

# FH3704B

## N-Channel Trench Power MOSFET

### Description

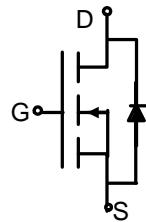
These N Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

### Features

- ◆ 40V,170A, $R_{DS(on),max}=3.5m\Omega @ V_{GS} = 10V$
- ◆ Improved dv/dt capability
- ◆ Fast switching
- ◆ 100% EAS Guaranteed
- ◆ Green device available

### Applications

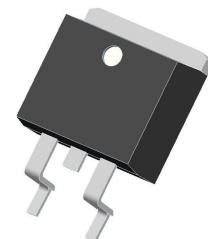
- ◆ Motor Drives
- ◆ UPS
- ◆ DC-DC Converter



Schematic diagram



Marking and pin assignment



TO-263 top view

### Absolute Maximum Ratings

$T_C = 25^\circ C$  unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	40	V
Continuous drain current ( $T_C = 25^\circ C$ ) <sup>1)</sup>	$I_D$	170	A
Continuous drain current ( $T_C = 100^\circ C$ ) <sup>1)</sup>		114	A
Pulsed drain current <sup>2)</sup>	$I_{DM}$	590	A
Gate-Source voltage	$V_{GSS}$	$\pm 20$	V
Avalanche energy <sup>3)</sup>	$E_{AS}$	544	mJ
Power Dissipation ( $T_C = 25^\circ C$ )	$P_D$	186	W
Storage Temperature Range	$T_{STG}$	-55 to +150	°C
Operating Junction Temperature Range	$T_J$	-55 to +150	°C

### Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.88	°C/W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	62.5	°C/W

**Electrical Characteristics** $T_J = 25^\circ\text{C}$  unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static characteristics</b>						
Drain-source breakdown voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0 \text{ V}, I_D=250 \mu\text{A}$	40	---	--	V
Gate threshold voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}}=V_{\text{GS}}, I_D=250 \mu\text{A}$	1.3		2.5	V
Drain source leakage current	$I_{\text{DSS}}$	$V_{\text{DS}}=40 \text{ V}, V_{\text{GS}}=0 \text{ V}, T_J = 25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=40 \text{ V}, V_{\text{GS}}=0 \text{ V}, T_J = 125^\circ\text{C}$	---	---	5	$\mu\text{A}$
Gate leakage current Forward	$I_{\text{GSSF}}$	$V_{\text{GS}}=20 \text{ V}, V_{\text{DS}}=0 \text{ V}$			100	nA
Gate leakage current Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}}=-20 \text{ V}, V_{\text{DS}}=0 \text{ V}$	---	---	-100	nA
Drain source on state resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}}=10 \text{ V}, I_D=20 \text{ A}$		2.5	3.5	$\text{m}\Omega$
		$V_{\text{GS}}=4.5 \text{ V}, I_D=10 \text{ A}$	---	3.5	6.0	$\text{m}\Omega$
Forward transconductance	$g_{\text{f}}$	$V_{\text{DS}}=5 \text{ V}, I_D=50 \text{ A}$	26	---	---	S
<b>Dynamic characteristics</b>						
Input capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 20 \text{ V}, V_{\text{GS}} = 0 \text{ V}, F = 1 \text{MHz}$		7810		pF
Output capacitance	$C_{\text{oss}}$			677		
Reverse transfer capacitance	$C_{\text{rss}}$			370		
Turn on delay time	$t_{\text{d(on)}}$	$V_{\text{DD}} = 20 \text{ V}, V_{\text{GS}} = 10 \text{ V}, I_D = 20 \text{ A}$		15		ns
Rise time	$t_r$		---	17	---	
Turn-off delay time	$t_{\text{d(off)}}$		---	52	---	
Fall time	$t_f$			23		
Gate resistance	$R_g$	$V_{\text{GS}}=0 \text{ V}, V_{\text{DS}}=0 \text{ V}, F=1 \text{MHz}$	---	2.12	---	$\Omega$
<b>Gate charge characteristics</b>						
Gate to source charge	$Q_{\text{gs}}$	$V_{\text{DS}}=20 \text{ V}, I_D=100 \text{ A}, V_{\text{GS}}=10 \text{ V}$	---	36.4	---	nC
Gate to drain charge	$Q_{\text{gd}}$		---	37.3	---	
Gate charge total	$Q_g$		---	139	---	
<b>Drain-Source diode characteristics and Maximum Ratings</b>						
Continuous Source Current	$I_s$		---	---	170	A
Pulsed Source Current <sup>4)</sup>	$I_{\text{SM}}$		---	---	590	A
Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0 \text{ V}, I_s=50 \text{ A}, T_J=25^\circ\text{C}$			1.2	V
Reverse Recovery Time	$t_{\text{rr}}$	$s=100 \text{ A}, di/dt=100 \text{ A/us}, T_J=25^\circ\text{C}$		42		ns
Reverse Recovery Charge	$Q_{\text{rr}}$			120		nC

Notes:

- 1: The maximum junction current rating is package limited.
- 2: Repetitive Rating: Pulse width limited by maximum junction temperature
- 3:  $V_{\text{DD}}=20 \text{ V}, V_{\text{GS}}=10 \text{ V}, L=1 \text{ mH}, I_{\text{AS}}=33 \text{ A}, R_G=25 \Omega$ , Starting  $T_J=25^\circ\text{C}$ .
- 4: Pulse Test: Pulse Width  $\leq 300 \mu\text{ s}$ , Duty Cycle  $\leq 2\%$

## Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

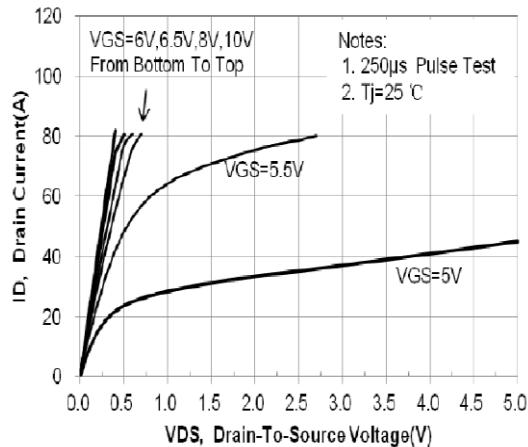


Figure 3. Capacitance Characteristics

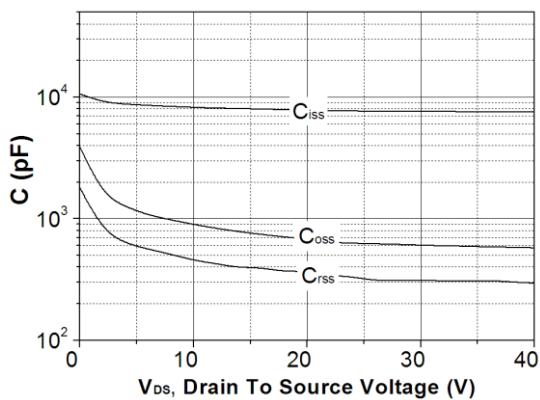


Figure 5. Body-Diode Characteristics

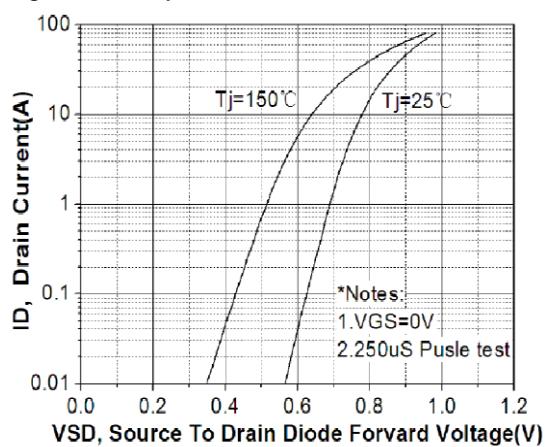


Figure 2. Transfer Characteristics

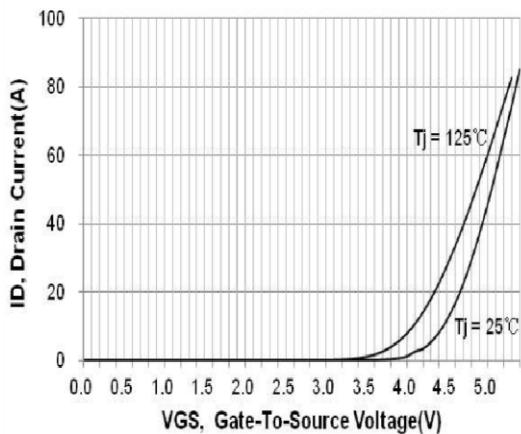


Figure 4. Gate Charge Waveform

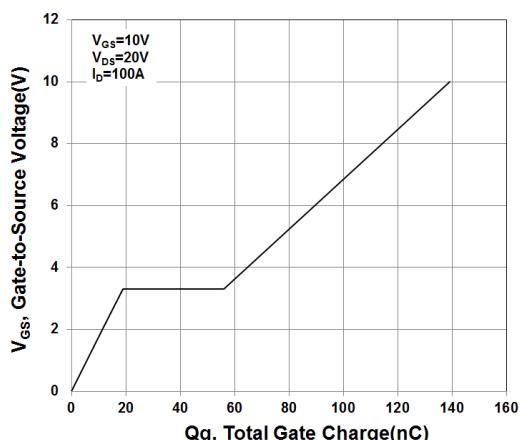


Figure 6. Normalized Maximum Transient Thermal Impedance (RthJC)

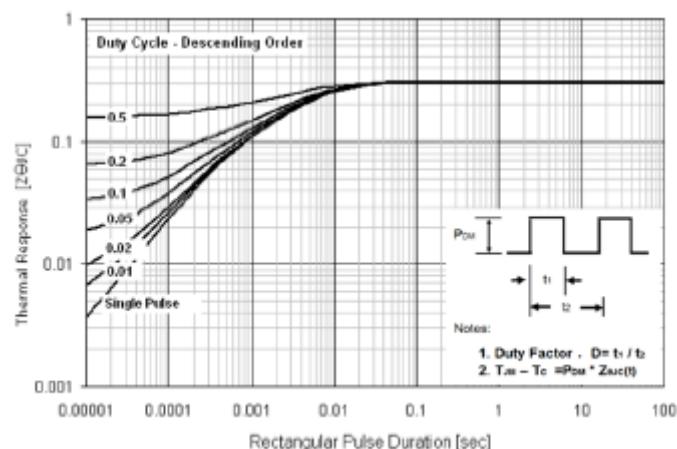
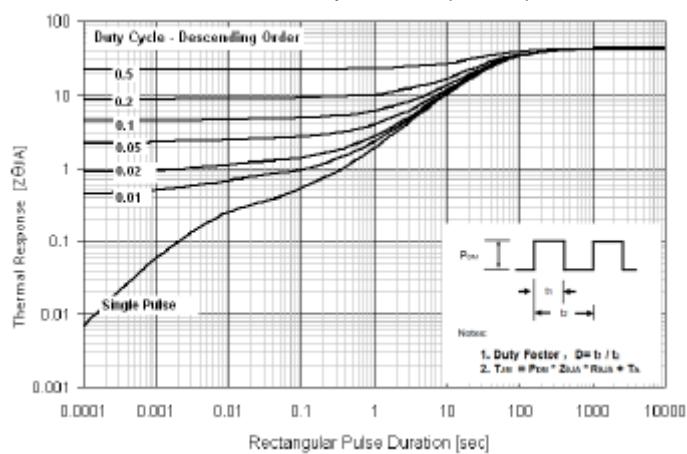


Figure 7. Normalized Maximum Transient Thermal Impedance (RthJA)



**Test Circuit & Waveform**

Figure 8. Gate Charge Test Circuit &amp; Waveform

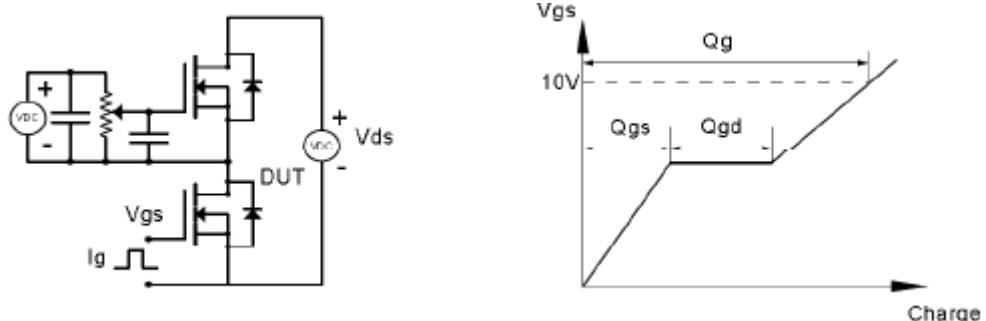


Figure 9. Resistive Switching Test Circuit &amp; Waveforms

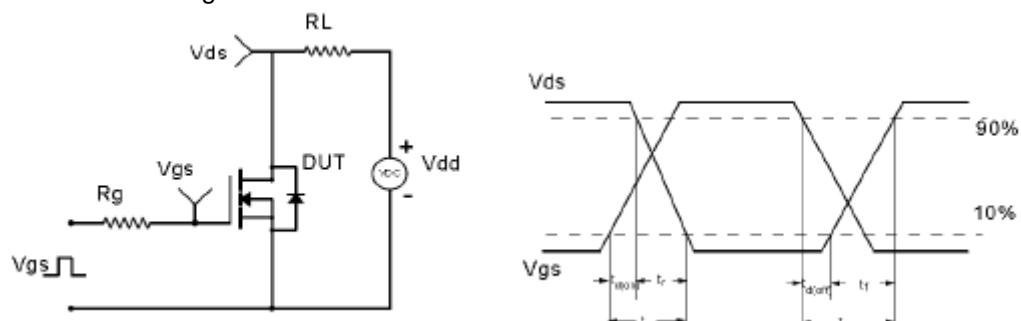


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit &amp; Waveform

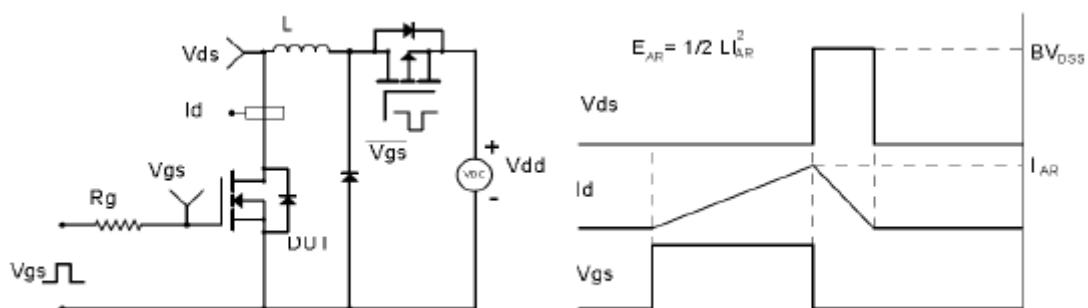
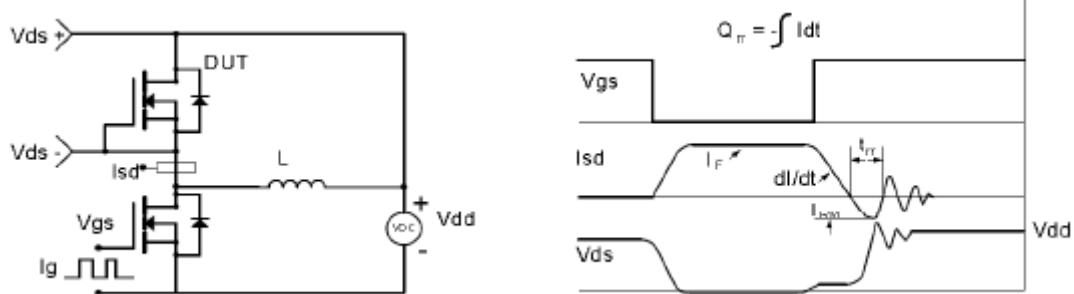
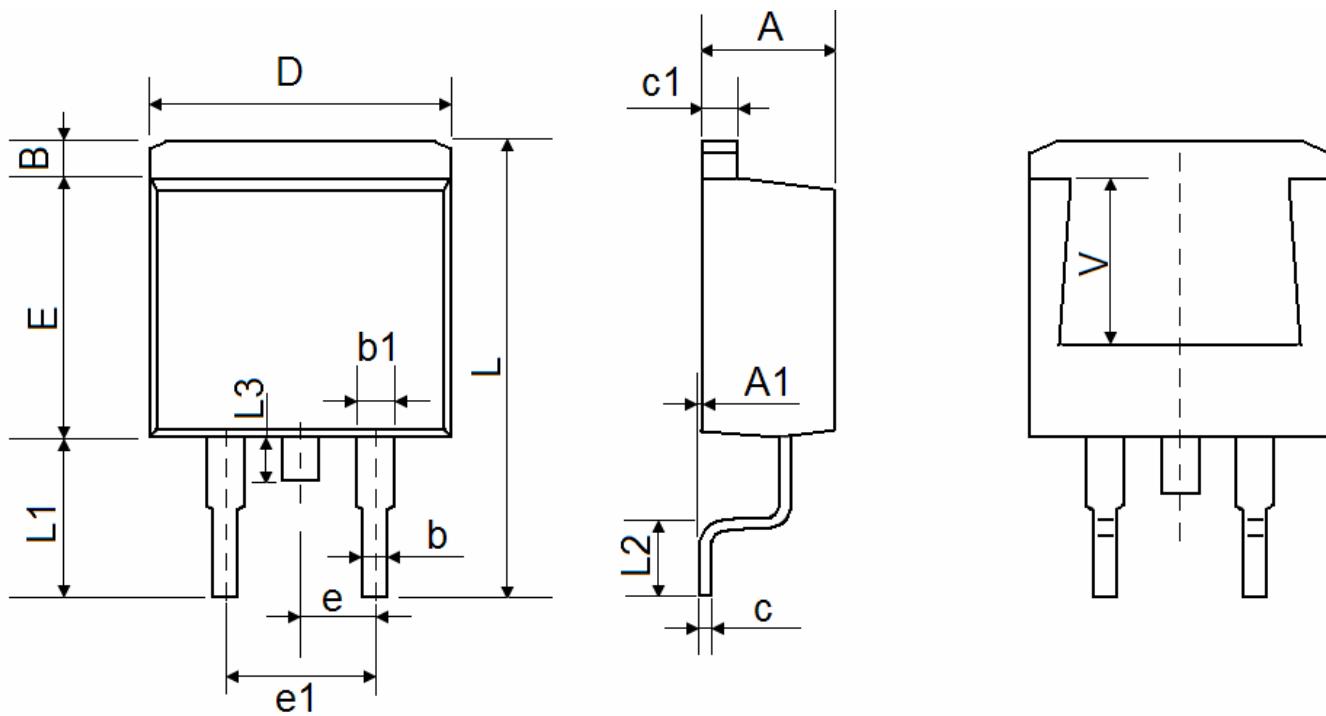


Figure 11. Diode Recovery Circuit &amp; Waveform



## Package Information : TO-263



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.470	4.670	0.176	0.184
A1	0.000	0.150	0.000	0.006
B	1.170	1.370	0.046	0.054
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.310	0.530	0.012	0.021
c1	1.170	1.370	0.046	0.054
D	10.010	10.310	0.394	0.406
E	8.500	8.900	0.335	0.350
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
L	15.050	15.450	0.593	0.608
L1	5.080	5.480	0.200	0.216
L2	2.340	2.740	0.092	0.108
L3	1.300	1.700	0.051	0.067
V	5.600 REF		0.220 REF	